

Description

The ES1F is a high voltage fast recovery diode of $1500\,V\,/\,0.5\,A.$

Features

•	V _{RM} 1500	V
•	$I_{F(AV)}$ 0.5	A
	V _F 2.0	
•	t _{rr1} 1.5 ı	LS

- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

• High Voltage Rectification Circuit (Bridge Circuit, etc.)

Package

Axial (φ 2.7 × 5.0L / φ 0.78)





- (1) Cathode
- (2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V _{RSM}		1500	V
Repetitive Peak Reverse Voltage	V_{RM}		1500	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	0.5	A
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	20	A
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	2.0	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 0.5 \text{A}$	_	_	2.0	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 0.5 \text{A}$	_	1.0	_	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	10	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100 ^{\circ}C$	_		200	μΑ
Decrees Decrees Time	$\mathbf{t}_{\mathrm{rr}1}$	$I_F = I_{RP} = 10 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_	_	1.5	μs
Reverse Recovery Time	t _{rr2}	$I_F = 10 \text{ mA}, I_{RP} = 20 \text{ mA},$ 75% recovery point, $T_J = 25 \text{ °C}$	—	_	0.6	μs
Thermal Resistance (1)	R _{th(J-L)}	See Figure 1.	_	_	17	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight			0.3		g

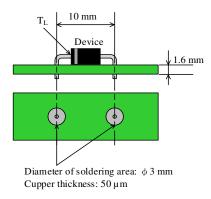
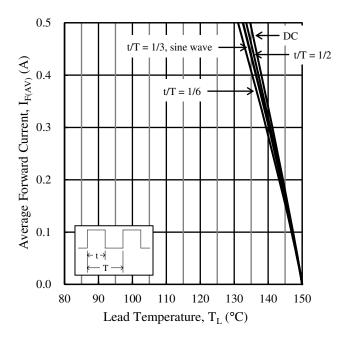


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}R_{th\,(J-L)}$ is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

Derating Curves



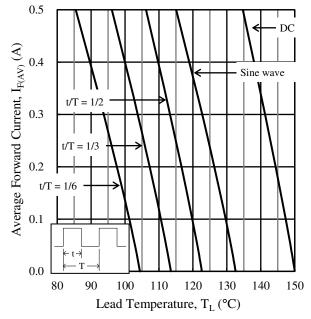


Figure 2. $I_{F(AV)}$ vs. $T_L^{(2)}$ $(T_J = 150 \, ^{\circ}\text{C}, \, V_R = 0 \, \text{V})$

Figure 3. $I_{F(AV)}$ vs. $T_L^{(2)}$ ($T_J = 150$ °C, $V_R = 1500$ V)

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Characteristic Curves

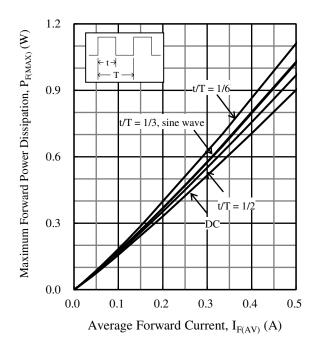


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

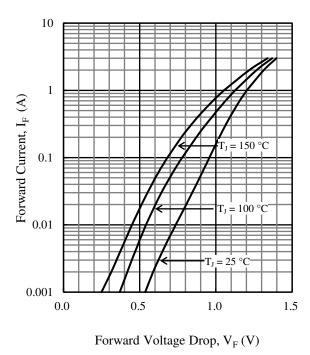


Figure 6. Typical Characteristics: I_F vs. V_F

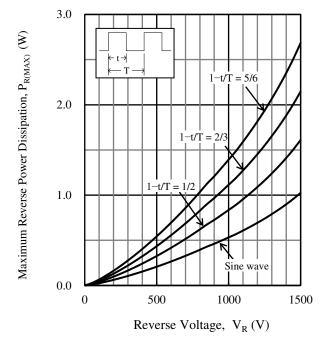


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

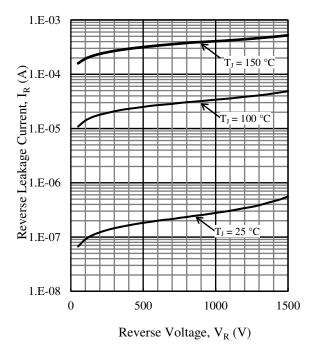


Figure 7. Typical Characteristics: I_R vs. V_R

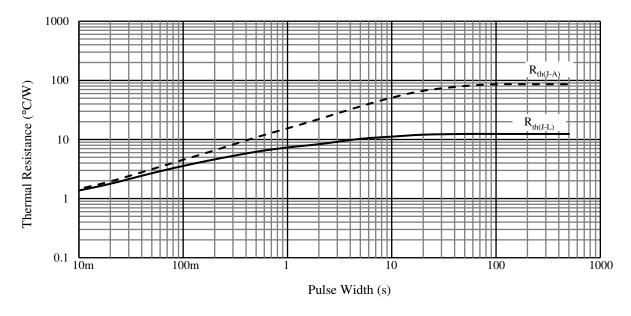
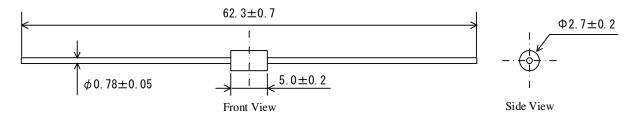


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• Axial $(\phi 2.7 \times 5.0 \text{L} / \phi 0.78)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- The total length of the product is the dimension when delivered separately and depends on the taping and lead forming specifications.
- The allowance position of body against the center of the total length of the product is 0.5 mm (max.); see Front View.
- The allowance position of lead against the center of body is 0.2 mm (max.); see Side View.
- The burr may exist up to 2 mm from the body of lead root.
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 °C / 10 s, 1 time
 Soldering Iron: 350 °C / 3.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

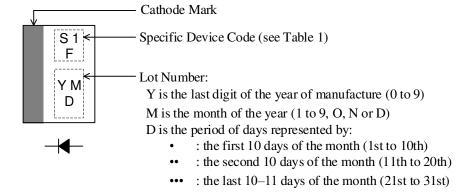


Table 1. Specific Device Code

Specific Device Code	Part Number
S1F	ES1F

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